

HAT2108R

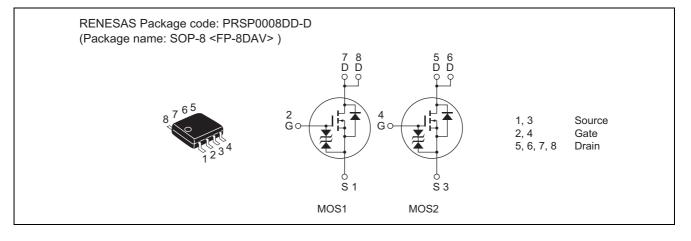
Silicon N Channel Power MOS FET High Speed Power Switching

> REJ03G1188-0500 (Previous: ADE-208-1574C) Rev.5.00 Sep 07, 2005

## Features

- Low on-resistance
- Capable of 2.5 V gate drive
- Low drive current
- High density mounting

## Outline





## **Absolute Maximum Ratings**

		$(Ta = 25^{\circ}C)$
Symbol	Value	Unit
V <sub>DSS</sub>	28	V
V <sub>GSS</sub>	±12	V
ID	11	А
I <sub>D (pulse)</sub> Note 1	88	А
I <sub>DR</sub>	11	А
Pch Note 2	2	W
Pch Note 3	3	W
Tch	150	٥C
Tstg	-55 to +150	٥C
	VDSS VGSS ID ID ID (pulse) Note 1 IDR Pch Note 2 Pch Note 3 Tch	VDSS         28           VGSS         ±12           ID         11           ID (pulse)         88           IDR         11           Pch         72           Pch         3           Tch         150

Notes: 1. PW  $\leq$  10  $\mu s,\,duty\,cycle \leq$  1%

2. 1 Drive operation: When using the glass epoxy board (FR4 40  $\times$  40  $\times$  1.6 mm), PW  $\leq$  10 s

3. 2 Drive operation: When using the glass epoxy board (FR4 40  $\times$  40  $\times$  1.6 mm), PW  $\leq$  10 s

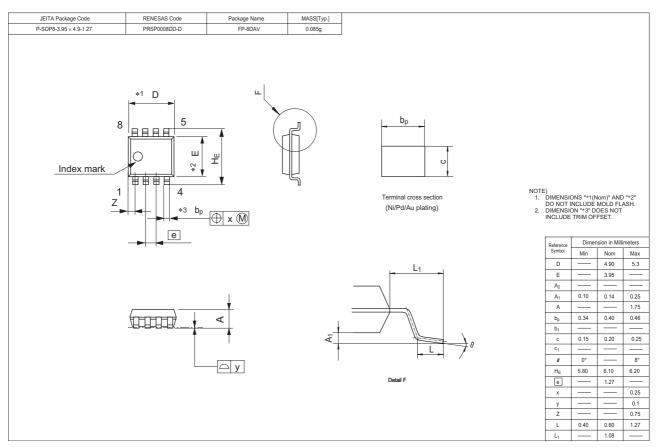
## **Electrical Characteristics**

 $(Ta = 25^{\circ}C)$ **Test Conditions** Item Symbol Min Тур Max Unit 28  $I_D = 10 \text{ mA}, V_{GS} = 0$ Drain to source breakdown voltage V (BR) DSS \_\_\_\_ \_ V V  $I_G=\pm 100~\mu A,~V_{DS}=0$ Gate to source breakdown voltage V (BR) GSS ±12 ±10  $V_{GS}=\pm 10~V,~V_{DS}=0$ Gate to source leak current Igss \_ \_ μΑ Zero gate voltage drain current IDSS \_\_\_ \_ 1 μΑ  $V_{DS} = 28 \text{ V}, \text{ V}_{GS} = 0$ Gate to source cutoff voltage 0.4 1.4 V  $V_{DS} = 10 \text{ V}, I_D = 1 \text{ mA}$ V<sub>GS (off)</sub> \_ Static drain to source on state resistance 12 15  $I_D = 5.5 \text{ A}, V_{GS} = 4 \text{ V}^{Note 4}$ R<sub>DS (on)</sub> mΩ  $I_D = 5.5 \text{ A}, V_{GS} = 2.5 \text{ V}^{Note 4}$ R<sub>DS (on)</sub> 15 22 mΩ  $I_D = 5.5 \text{ A}, V_{DS} = 10 \text{ V}^{\text{Note 4}}$ Forward transfer admittance 17 28 S y<sub>fs</sub> \_ Input capacitance Ciss \_ 2200 \_\_\_ pF  $V_{DS} = 10 V$ 400  $V_{GS} = 0$ Output capacitance Coss pF \_ \_\_\_\_ 240 f = 1 MHzReverse transfer capacitance Crss pF Total gate charge Qg 16 nC  $V_{DD} = 10 V$ Gate to source charge Qgs \_ 5.2 \_ nC  $V_{GS} = 4 V$  $I_{D} = 11 \text{ A}$ Gate to drain charge Qgd \_ 4.8 \_ nC 30  $V_{GS} = 4 V, I_D = 5.5 A$ Turn-on delay time t<sub>d (on)</sub> \_ \_ ns  $V_{DD} \cong 10 \text{ V}$ Rise time 35 tr ns  $R_L = 1.81 \ \Omega$ Turn-off delay time t<sub>d (off)</sub> \_ 70 \_ ns  $Rg = 4.7 \Omega$ Fall time \_ 25 \_ ns tf  $I_F = 11 \text{ A}, V_{GS} = 0^{\text{Note 4}}$ Body-drain diode forward voltage  $V_{\text{DF}}$ 0.85 1.11 V \_  $I_F = 11 \text{ A}, V_{GS} = 0$ Body-drain diode reverse recovery time 40 trr \_ ns  $di_F/dt = 50 A/\mu s$ 

Note: 4. Pulse test



# **Package Dimensions**



# **Ordering Information**

Part Name	Quantity	Shipping Container
HAT2108R-EL-E	2500 pcs	Taping

Note: For some grades, production may be terminated. Please contact the Renesas sales office to check the state of production before ordering the product.



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